Apacer

RoHS Compliant

CFast 2 HS

CFast 2 HS Product Specifications

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Version 1.8



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Specifications Overview:

Standard Serial ATA Interface

- SATA Revision 3.1 compliance
- SATA 6 Gb/s interface speed
- Backward compatible with SATA 1.5 and 3 Gb/s interfaces
- ATA-compatible command set

Capacity

- 4, 8, 16, 32, 64 GB

Performance*

Sequential read: Up to 285 MB/secSequential write: Up to 260 MB/sec

• Flash Management

- Built-in hardware ECC
- Global Wear Leveling
- Flash bad-block management
- S.M.A.R.T.
- Power Failure Management
- Device Sleep (optional)
- ATA Secure Erase
- TRIM
- NAND Flash Type: SLC
- MTBF: >2,000,000 hours

Temperature Range

- Operating:

Standard: 0°C to 70°C Wide: -40°C to 85°C**

- Storage: -40°C to 100°C

Supply Voltage

 $-3.3 \text{ V} \pm 5\%$

Power Consumption*

Active mode: 500 mAIdle mode: 90 mA

Connector Type

- 7 + 17 pin female connector

Shock & Vibration***

Shock: 1,500 GVibration: 15 G

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^{*}Varies from capacities. The values for performances and power consumptions presented are typical and may vary depending on flash configurations or platform settings.

^{**}Available in 8, 16, 32 and 64GB models.

^{***}Non-operating

Table of Contents

2. Functional Block
4. Product Specifications 4.1 Capacity 4.2 Performance 4.3 Environmental Specifications 4.4 Mean Time Between Failures (MTBF) 4.5 Certification and Compliance 5. Flash Management
4. Product Specifications 4.1 Capacity 4.2 Performance 4.3 Environmental Specifications 4.4 Mean Time Between Failures (MTBF) 4.5 Certification and Compliance 5. Flash Management
4.1 Capacity
4.2 Performance 4.3 Environmental Specifications 4.4 Mean Time Between Failures (MTBF) 4.5 Certification and Compliance 5. Flash Management
4.3 Environmental Specifications
4.4 Mean Time Between Failures (MTBF) 4.5 Certification and Compliance 5. Flash Management
4.5 Certification and Compliance
5. Flash Management
5.1 Error Correction/Detection
5.2 Bad Block Management
5.3 Global Wear Leveling
5.4 ATA Secure Erase
5.5 Power Failure Management
5.6 TRIM
5.7 SATA Power Management Modes
5.8 DEVSLP (DevSleep or DEVSLP) Mode (optional)1
6. Software Interface1
6.1 Command Set1
6.2 S.M.A.R.T
7. Electrical Specifications1
7.1 Operating Voltage1
7.2 Power Consumption
8. Physical Characteristics14
9. Product Ordering Information1
9.1 Product Code Designations

1. General Descriptions

Apacer CFast 2 HS is the latest enhancement of conventional CFast form factor that delivers various technological advantages. This new flash memory card comes with SATA 6 Gb/s interface for higher performance and is compliant with standard CFast specifications. CFast 2 HS consists of SATA-based 7-pin signal segment and 17-pin for power and control purposes. It can offer moderate capacity and decent data transfer performance. For power efficiency, this new flash memory card leverages the technological benefits of SATA Revision 3.0 specifications. For data integrity, the CFast card is built with ECC engine correcting up to 72-bit. Together with its small form factor nature, Apacer CFast 2 HS is definitely the ideal solution to replace conventional PATA-based CompactFlash for applications in industrial computing systems, mobile computers and video processing instruments.

2. Functional Block

Apacer CFast 2 HS includes a single-chip SATA 6 Gb/s and the flash media. The controller integrates the flash management unit to support multi-channel, multi-bank flash arrays. Figure 2-1 shows the functional block diagram.

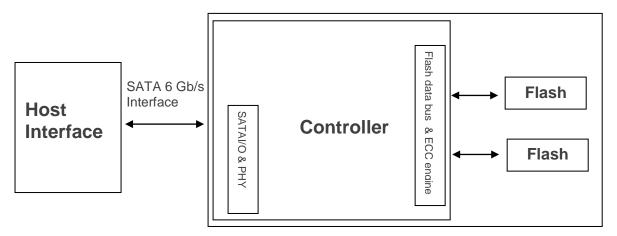


Figure 2-1 Functional Block Diagram

3. Pin Assignments

Table 3-1 describes CFast 2 HS signal segment, and Table 3-2, its power segment.

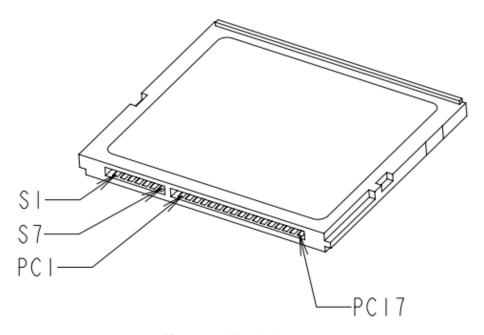


Figure 3-1 Pin Assignment

Table 3-1 Signal Segment

Pin	Definition	Description
S1	GND	Ground
S2	A+	SATA Differential
S3	A-	Signal Pair A
S4	GND	Ground
S5	B-	SATA Differential
S6	B+	Signal Pair B
S7	GND	Ground

Pin	Definition	Туре	Description	
PC1	CDI	Input	Card Detect In	
PC2	PGND	Device GND	Device GND	
PC3			DEVSLP enable	
PC4			Reserved	
PC5			Reserved	
PC6			Reserved	
PC7	PGND	Device GND	Device GND	
PC8	LED1	LED Output	Power indicator	
PC9	LED2	LED Output	Access indicator	
PC10			Reserved	
PC11			Write Protect**	
PC12	IFDet	GND	Card output, connect to PGND on card	
PC13	PWR	3.3V	Device power (3.3V)	
PC14	PWR	3.3V	Device power (3.3V)	
PC15	PGND	Device GND	Device GND	
PC16	PGND	Device GND	Device GND	
PC17	CDO	Output	Card Detect Out	

Table 3-2 Power Segment

Apacer implements the Virtual Write scheme that allows write commands to go through the flash controller and data is temporarily stored, but no data has been actually written into the flash. Once the host resets or restarts the system, all the temporarily stored data will disappear and nowhere to be found in the drive. Since the Virtual Write scheme runs at device level, it requires no software or driver installation and is independent from the host OS.

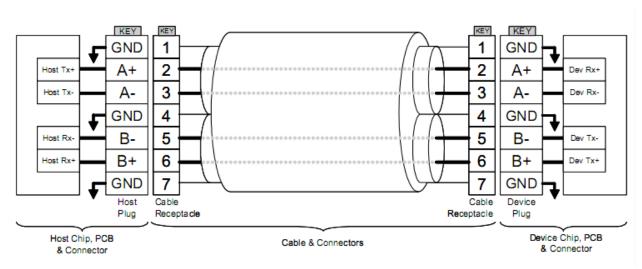


Figure 3-2 SATA Cable / Connector Connection Diagram

The connector on the left represents the Host with TX/RX differential pairs connected to a cable while the connector on the right shows the Device with TX/RX differential pairs also connected to the cable. Notice also the ground path connecting the shielding of the cable to the Cable Receptacle.

^{*}Optional

^{**}Enabled by adjusting the pin "PC11" from high to low active Notes about Write Protect:

4. Product Specifications

4.1 Capacity

Capacity specifications of CFast 2 HS are available as shown in Table 4-1. It lists the specific capacity and the default numbers of heads, sectors and cylinders for each product line.

Table 4-1 Capacity Specifications

Capacity	Total bytes*	Cylinders	Heads	Sectors	Max LBA
4 GB	4,011,614,208	7,773	16	63	7,835,184
8 GB	8,012,390,400	15,525	16	63	15,649,200
16 GB	16,013,942,784	16,383	16	63	31,277,232
32 GB	32,017,047,552	16,383	16	63	62,533,296
64 GB	64,023,257,088	16,383	16	63	125,045,424

^{*}Display of total bytes varies from file systems, which means not all of the bytes can be used for storage.

LBA count addressed in the table above indicates total user storage capacity and will remain the same throughout the lifespan of the device. However, the total usable capacity of the SSD is most likely to be less than the total physical capacity because a small portion of the capacity is reserved for device maintenance usages.

4.2 Performance

Performance of CFast 2 HS is listed below in Table 4-2.

Table 4-2 Performance Specifications

Capacity Performance	4 GB	8 GB	16 GB	32 GB	64 GB
Sequential Read* (MB/s)	220	220	285	285	285
Sequential Write* (MB/s)	60	65	135	260	260

Note:

Results may differ from various flash configurations or host system setting.

4.3 Environmental Specifications

Environmental specifications of CFast 2 HS product are shown in Table 4-3.

Table 4-3 Environmental Specifications

Item	Specifications		
Operating temp.	0°C to 70°C (Standard); -40°C to 85°C (Wide*)		
Non-operating temp.	-40°C to 100°C		
Operating vibration	7.69 GRMS, 20~2000 Hz/random (compliant with MIL-STD-810G)		
Non-operating vibration	4.02 GRMS, 15~2000 Hz/random (compliant with MIL-STD-810G)		
Operating shock	50G, 11ms		
Non-operating shock	1500G, 0.5ms (compliant with MIL-STD-883K)		

Note: This Environmental Specification table indicates the conditions for testing the device. Real world usages may affect the results.*Available in 8, 16, 32, and 64GB models

^{**}Notes: 1 GB = 1,000,000,000 bytes; 1 sector = 512 bytes.

^{*}Sequential performance is based on CrystalDiskMark 5.2.1 with file size 1,000MB.

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4.4 Mean Time Between Failures (MTBF)

Mean Time Between Failures (MTBF) is predicted based on reliability data for the individual components in CFast 2 HS. The prediction result for CFast 2 HS is more than 2,000,000 hours.

Note: The MTBF is predicated and calculated based on "Telcordia Technologies Special Report, SR-332, Issue 2" method.

4.5 Certification and Compliance

CFast 2 HS complies with the following standards:

- CE
- FCC
- RoHS
- MIL-STD-810G

5. Flash Management

5.1 Error Correction/Detection

Apacer implements a hardware ECC scheme, based on the BCH algorithm. It can detect and correct up to 40 bits error in 1K bytes.

5.2 Bad Block Management

Current production technology is unable to guarantee total reliability of NAND flash memory array. When a flash memory device leaves factory, it comes with a minimal number of initial bad blocks during production or out-of-factory as there is no currently known technology that produce flash chips free of bad blocks. In addition, bad blocks may develop during program/erase cycles. When host performs program/erase command on a block, bad block may appear in Status Register. Since bad blocks are inevitable, the solution is to keep them in control. Apacer flash devices are programmed with ECC, page mapping technique and S.M.A.R.T to reduce invalidity or error. Once bad blocks are detected, data in those blocks will be transferred to free blocks and error will be corrected by designated algorithms.

5.3 Global Wear Leveling

Flash memory devices differ from Hard Disk Drives (HDDs) in terms of how blocks are utilized. For HDDs, when a change is made to stored data, like erase or update, the controller mechanism on HDDs will perform overwrites on blocks. Unlike HDDs, flash blocks cannot be overwritten and each P/E cycle wears down the lifespan of blocks gradually. Repeatedly program/erase cycles performed on the same memory cells will eventually cause some blocks to age faster than others. This would bring flash storages to their end of service term sooner. Global wear leveling is an important mechanism that levels out the wearing of all blocks so that the wearing-down of all blocks can be almost evenly distributed. This will increase the lifespan of SSDs.

5.4 ATA Secure Erase

ATA Secure Erase is an ATA disk purging command currently embedded in most of the storage drives. Defined in ATA specifications, (ATA) Secure Erase is part of Security Feature Set that allows storage drives to erase all user data areas. The erase process usually runs on the firmware level as most of the ATA-based storage media currently in the market are built-in with this command. ATA Secure Erase can securely wipe out the user data in the drive and protects it from malicious attack.

5.5 Power Failure Management

Power Failure Management plays a crucial role when experiencing unstable power supply. Power disruption may occur when users are storing data into the SSD. In this urgent situation, the controller would run multiple write-to-flash cycles to store the metadata for later block rebuilding. This urgent operation requires about several milliseconds to get it done. At the next power up, the firmware will perform a status tracking to retrieve the mapping table and resume previously programmed NAND blocks to check if there is any incompleteness of transmission.

5.6 TRIM

TRIM is a SATA command that helps improve the read/write performance and efficiency of solid-state drives (SSD). The command enables the host operating system to inform SSD controller which blocks contain invalid data, mostly because of the erase commands from host. The invalid will be discarded permanently and the SSD will retain more space for itself.

5.7 SATA Power Management Modes

By complying with SATA 6 Gb/s specifications, the SSD supports the following SATA power saving modes:

- ACTIVE: PHY ready, full power, Tx & Rx operational
- PARTIAL: Reduces power, resumes in under 10 μs (microseconds)
- SLUMBER: Reduces power, resumes in under 10 ms (milliseconds)
- HIPM: Host-Initiated Power Management
- DIPM: Device-Initiated Power Management
- AUTO-SLUMBER: Automatic transition from partial to slumber.
- Device Sleep (DevSleep or DEVSLP): PHY powered down; power consumption \leq 5 mW; host assertion time \leq 10 ms; exit timeout from this state \leq 20 ms (unless specified otherwise in SATA Identify Device Log).

Note

- 1. The behaviors of power management features would depend on host/device settings.
- 2. Device Sleep mode is optional depending on product ordering selections.

5.8 DEVSLP (DevSleep or DEVSLP) Mode (optional)

Device Sleep is a feature that allows SATA devices to enter a low power mode by designating a particular pin as DEVSLP signal with an aim to reducing power consumption.



		SATA, mSATA, M.2	
Parameter	Description & Conditions	Min	Max
V_{DIn}	Tolerated input voltage.	-0.5 V	3.6 V
V _{HAssert}	Voltage presented to host if signal not driven low. Value specified for all allowable I _{HAssert} .	-	2.4 V
I _{HNegate}	Device current delivered to host if host driving signal low. Value specified at V_{HNegate} voltage of 0 V.	-	100 uA

6. Software Interface

6.1 Command Set

Table 6-1 Command Set

Code	Command	Code	Command
E5h	CHECK POWER MODE	F6h	SECURITY DISABLE
90h	EXECUTE DIAGNOSTICS	F3h	SECURITY ERASE
E7h	FLUSH CACHE	F4h	SECURITY ERASE UNIT
ECh	IDENTIFY DEVICE	F5h	SECURITY FREEZE
E3h	IDLE	F1h	SECURITY SET
E1h	IDLE IMMEDIATE	F2h	SECURITY UNLOCK
91h	INITIALIZE DEVICE	7xh	SEEK
C8h	READ DMA	Efh	SET FEATURES
25h	READ DMA EXT	C6h	SET MULTIPLE MODE
60h	READ FPDMA QUEUED	E6h	SLEEP
47h	READ LOG DMA EXT	B0h	S.M.A.R.T.
2Fh	READ LOG EXT	E2h	STANDBY
C4h	READ MULTIPLE	E0h	STANDBY IMMEDIATE
20 or 21h	READ SECTOR(S)	Cah	WRITE DMA
40 or 41h	READ VERIFY SECTOR(S)	35h	WRITE DMA EXT
10h	RECALIBRATE	61h	WRITE FPDMA QUEUED
57h	WRITE LOG DMA EXT	3Fh	WRITE LOG EXT
C5h	WRITE MULTIPLE	30h or 31h	WRITE SECTOR(S)

6.2 S.M.A.R.T.

S.M.A.R.T. is an abbreviation for Self-Monitoring, Analysis and Reporting Technology, a self-monitoring system that provides indicators of drive health as well as potential disk problems. It serves as a warning for users from unscheduled downtime by monitoring and displaying critical drive information. Ideally, this should allow taking proactive actions to prevent drive failure and make use of S.M.A.R.T. information for future product development reference.

Apacer devices use the standard SMART command B0h to read data out from the drive to activate our S.M.A.R.T. feature that complies with the ATA/ATAPI specifications. S.M.A.R.T. Attribute IDs shall include initial bad block count, total later bad block count, maximum erase count, average erase count, power on hours and power cycle. When the S.M.A.R.T. Utility running on the host, it analyzes and reports the disk status to the host before the device reaches in critical condition.

Note: Attribute IDs may vary from product models due to various solution design and supporting capabilities.

Apacer memory products come with S.M.A.R.T. commands and subcommands for users to obtain information of drive status and to predict potential drive failures. Users can take advantage of the following commands/subcommands to monitor the health of the drive.

Code	SMART Subcommand
D0h	READ DATA
D1h	READ ATTRIBUTE THRESHOLDS
D2h	ENABLE/DISABLE ATTRIBUTE AUTOSAVE
D4h	EXECUTE OFF-LINE IMMEDIATE
D5h	SMART READ LOG
D6h	SMART WRITE LOG
D8h	ENABLE OPERATIONS
D9h	DISABLE OPERATIONS
DAh	RETURN STATUS

General SMART attribute structure

Byte	Description
0	ID (Hex)
1 – 2	Status Flag
3	Value
4	Worst
5*-11	Raw Data

*Byte 5: LSB

SMART attribute ID list

ID (Hex)	Attribute Name
9 (0x09)	Power-on Hours
12 (0x0C)	Power Cycle Count
163 (0xA3)	Max. Erase Count
164 (0xA4)	Avg. Erase Count
166 (0xA6)	Total Later Bad Block Count
167 (0xA7)	SSD Protect Mode (Vendor Specific)
168 (0xA8)	SATA PHY Error Count
171 (0xAB)	Program Fail Count
172 (0xAC)	Erase Fail Count
175 (0xAF)	Bad Cluster Table Count
192 (0xC0)	Unexpected Power Loss Count
194 (0xC2)	Temperature
231 (0xE7)	Lifetime Left
241 (0xF1)	Total Sectors of Write

7. Electrical Specifications

7.1 Operating Voltage

Table 7-1 lists the supply voltage for CFast 2 HS.

Table 7-1 Operating Range

Parameter	Symbol	Min	Туре	Max	Units
Power Supply	Vcc	3.135	3.3	3.465	V

7.2 Power Consumption

Table 7-2 lists the power consumption for CFast 2 HS.

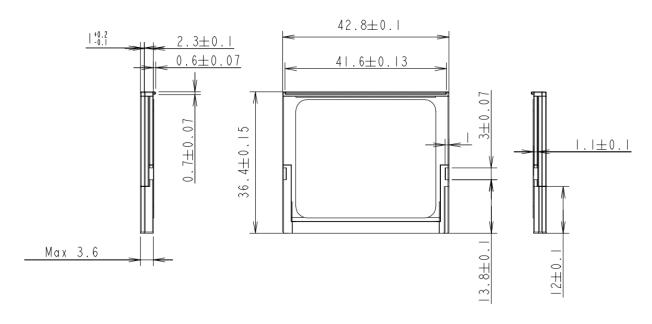
Table 7-2 Power Consumption

Capacity Mode	4 GB	8GB	16 GB	32 GB	64 GB
Active (mA)	265	240	275	390	500
Idle (mA)	90	90	90	90	90

^{*}All values are typical and may vary depending on flash configurations or host system settings.

**Active power is an average power measurement performed using CrystalDiskMark with 128KB sequential read/write transfers.

8. Physical Characteristics



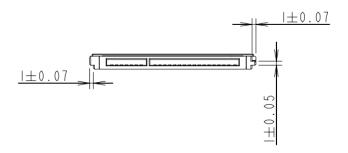
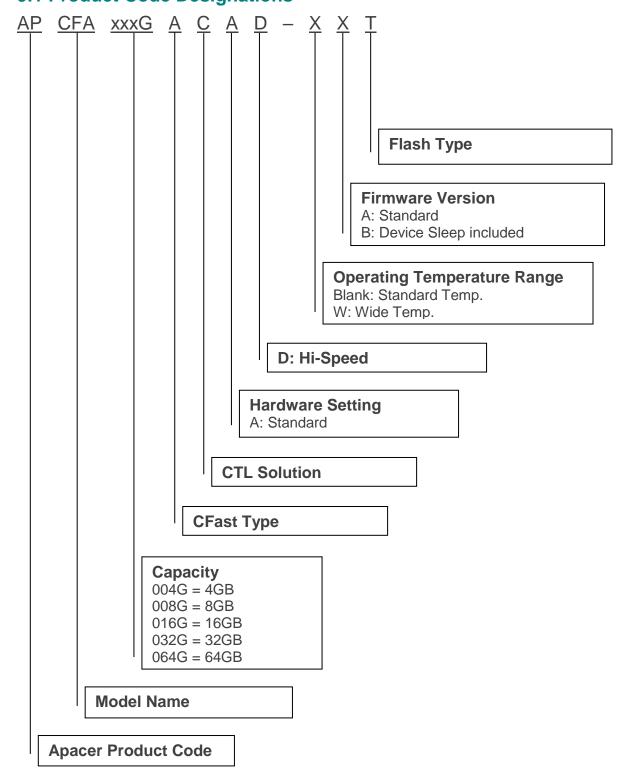


Figure 8-1 Physical Dimensions

Unit: mm

9. Product Ordering Information

9.1 Product Code Designations



9.2 Valid Combinations

9.2.1 Standard Temperature

Capacity	Standard	DEVSLP	
4GB	APCFA004GACAD-AT	APCFA004GACAD-BT	
8GB	APCFA008GACAD-AT	APCFA008GACAD-BT	
16GB	APCFA016GACAD-AT	APCFA016GACAD-BT	
32GB	APCFA032GACAD-AT	APCFA032GACAD-BT	
64GB	APCFA064GACAD-AT	APCFA064GACAD-BT	

9.2.2 Wide Temperature

Capacity	Standard	DEVSLP
8GB	APCFA008GACAD-WAT	APCFA008GACAD-WBT
16GB	APCFA016GACAD-WAT	APCFA016GACAD-WBT
32GB	APCFA032GACAD-WAT	APCFA032GACAD-WBT
64GB	APCFA064GACAD-WAT	APCFA064GACAD-WBT

Note: Valid combinations are those products in mass production or will be in mass production. Consult your Apacer sales representative to confirm availability of valid combinations and to determine availability of new combinations.

Revision History

Revision	Description	Date
0.1	Preliminary	11/19/2013
1.0	Official release	11/26/2013
1.1	Added Endurance (TBW) section	12/19/2013
1.2	Removed 64GB from the Product Ordering Information due to consideration about availability	1/21/2014
1.3	Updated power consumption due to firmware revision	2/13/2014
1.4	Added 64GB information	4/16/2014
1.5	Revised mechanical drawing	5/22/2014
1.6	Removed 4GB from extended temperature specifications	6/26/2014
1.7	Revised the mechanical drawing	9/24/2014
1.8	 Changed extended temperature to wide temperature Changed SATA 6.0 Gbps to SATA 6 Gb/s in accordance with SATA naming guidelines Updated operating/non-operating vibration spec at Table 4-3 Environmental Specifications Changed MIL-STD to MIL-STD-810G at 4.5 Certification and Compliance Capitalized every letter for commands at 6.1 Command Set and SMART subcommand at 6.2 S.M.A.R.T. 	3/20/2020

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